

SPW

Docket No.: X2007.0137
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Fumiaki Sasaki et al.

Application No.: 10/653,352

Confirmation No.: 3035

Filed: August 28, 2003

Art Unit: 1742

For: HIGH STRENGTH COPPER ALLOY AND
MANUFACTURING METHOD
THEREFOR

Examiner: Not Yet Assigned

REQUEST FOR CORRECTED FILING RECEIPT

Filing Receipt Corrections
Office of Initial Patent Examination
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

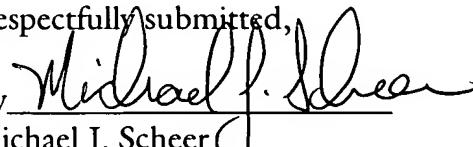
Applicant hereby requests that a corrected Filing Receipt be issued in the above-identified patent application. The official Filing Receipt received by Applicant, a copy of which is attached hereto, has an error in Filing Date of the application.

The application was hand-delivered to the U.S. Patent and Trademark Office on August 28, 2004. However, the Filing Receipt indicates a filing date of September 2, 2004. We are enclosing a postcard, date stamped, indicating August 28, 2004 as the date in which the application was received into the Office of Initial Patent Examination.

Applicant additionally requests that all pertinent U.S. Patent and Trademark Office records relating to the subject application be changed to reflect this correction.

Dated: June 3, 2004

Respectfully submitted,

By 
Michael J. Scheer

Registration No. 34,425
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JUN 03 2004
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UNITED STATES DEPARTMENT OF COMMERCE
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APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY.DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/653,352	09/02/2003 08/28/0003	1742	1030	X2007.0137	6	6	2

CONFIRMATION NO. 3035

FILING RECEIPT



OC000000011346722

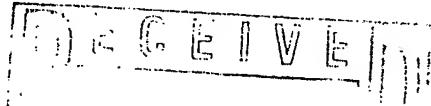
32172
DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP
1177 AVENUE OF THE AMERICAS (6TH AVENUE)
41 ST FL.
NEW YORK, NY 10036-2714

Date Mailed: 11/24/2003

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

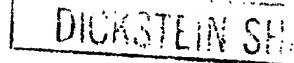
Fumiaki Sasaki, Fukuroi-shi, JAPAN;
Yozo Tsugane, Asaba-cho, JAPAN;



Domestic Priority data as claimed by applicant

Foreign Applications

JAPAN 2002-255937 08/30/2002



If Required, Foreign Filing License Granted: 11/24/2003

Projected Publication Date: 03/04/2004

Non-Publication Request: No

DOCNO FILE NO. X2007.0137
DATE: _____
C/L: _____
ENTERED BY: HJM SW
ATTY: _____

Title

High strength copper alloy and manufacturing method therefor

Preliminary Class

**LICENSE FOR FOREIGN FILING UNDER
Title 35, United States Code, Section 184
Title 37, Code of Federal Regulations, 5.11 & 5.15**

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Atty Docket No.: X2007.0137

Inventor: Fumiaki Sasaki, et al.

Application No.: Not Yet Assigned Filing Date: Concurrently Herewith
Title: HIGH STRENGTH COPPER ALLOY AND MANUFACTURING METHOD
THEREFOR

Documents Filed:

Fee Transmittal (1 page)

Recordation Form Cover Sheet (1 page)

Utility Patent Application Transmittal (1 page)

Assignment (3 pages)

Specification (16 pages)

Information Disclosure Statement (3 pages)

6 drawings (6 sheets)

IDS Citation (1 page)

Oath or declaration (4 pages)

Copies of Information Disclosure Citations

Claim for Priority and Submission of Documents
(2 pages)

Payment by credit card. Form PTO-2038 is
attached (1 page)

Certified copy of Priority document
JP 2002-255937

Charge \$1,070.00 to credit card

Via:

Sender's Initials: SIW/MJT/djp

Date: August 28, 2003



8/28/03